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Customer Number

Patent
Case No.: 59383US007

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

First Named Inventor: **SHINOHARA, MASARU**

Application No.: **10/561,358** Confirmation No.: **5956**

Filed: **June 24, 2004**

Title: **HEAT RESISTANT MASKING TAPE**

DECLARATION UNDER 37 C.F.R. § 1.132

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CERTIFICATE OF MAILING OR TRANSMISSION [37 CFR § 1.8(a)]	
I hereby certify that this correspondence is being:	
<input checked="" type="checkbox"/> transmitted to United States Patent and Trademark Office on the date shown below via the Office electronic filing system.	
Date	Signed by: Susan P. Gumatz

June 3, 2009 *Susan P. Gumatz*

Date

Signed by: Susan P. Gumatz

Dear Sir or Madam:

I, Yorinobu Takamatsu, hereby state the following:

1. I am a named inventor of the above captioned patent application.
2. I am a named inventor of PCT Pub. Pat. App. WO 03/064552 A1 (Takeda et al.), and I am familiar with the disclosure of Takeda et al.
3. I have reviewed the claims presented in the above captioned patent application and the content of the disclosure of the above cited Takeda et al. application.
4. The subject matter of the above captioned patent application and the above cited Takeda et al. application, were, at the time the claimed inventions were made, both subject to an obligation of assignment to 3M Innovative Properties Company.
5. In addition, the named inventors of the above cited Takeda et al. application had access to information from the present inventors.
6. In support of our research, I and Masaru Shinohara, Yoong Kim, and Harumi Ushito, the named co-inventors of the above captioned patent application, conducted and/or directed the completion of a number of experiments to prepare heat resistant masking tapes as invented by us.
7. To the extent that the above cited Takeda et al. application and any disclosure therein relates to a heat resistant masking tape as claimed in the above captioned patent

application, such disclosure describes concepts developed by myself and the above referenced co-inventors of the above captioned patent application.

8. In particular, to the extent that Takeda et al. discloses in the Abstract, Example 1, Table 1 and pages 13-15, a heat resistant masking tape including a non-aqueous pressure-sensitive adhesive layer (or a pressure-sensitive adhesive layer comprising a polymer resulting from polymerizing and cross-linking a monomer mixture in an organic solvent) disposed on the treated surface of a heat resistant backing film layer as presently claimed in the above captioned patent application, such disclosure originated with or was obtained from the named co-inventors of the above captioned patent application.
9. I further believe that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further, that these statements and the like are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of this application or any patent issuing thereon.

DATE: 2009 / May . 11

SIGNATURE: *Yorinobu Takamatsu*

Yorinobu Takamatsu